

SRM20100LLM70/85/10

1M-Bit Static RAM

- Extremely Low Standby Current
- Access Time 70ns/85ns/100ns
- 131,072 Words×8-Bit Asynchronous

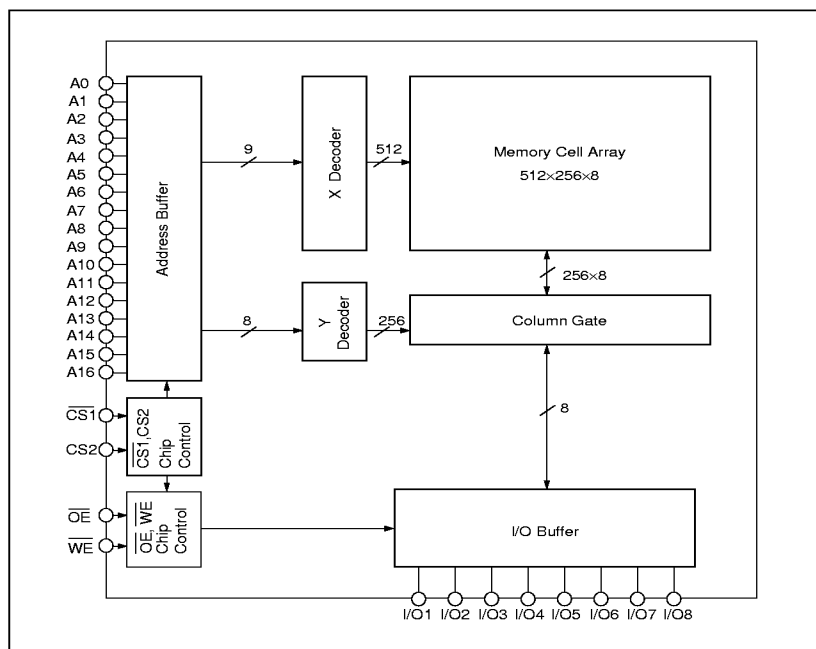
DESCRIPTION

The SRM20100LLM70/85/10 is an 131,072 words×8-bit asynchronous, static, random access memory on a monolithic CMOS chip. Its very low standby power requirement makes it ideal for applications requiring non-volatile storage with back-up batteries. The asynchronous and static nature of the memory requires no external clock or refreshing circuit. Both the input and output ports are TTL compatible and 3-state output allows easy expansion of memory capacity.

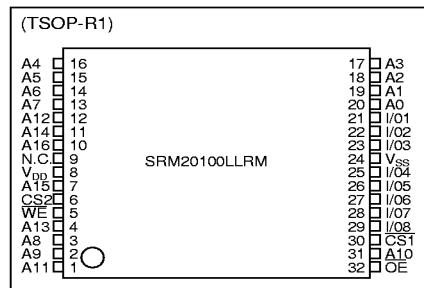
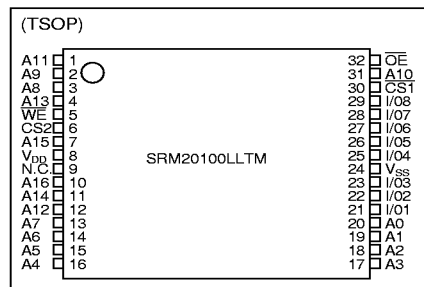
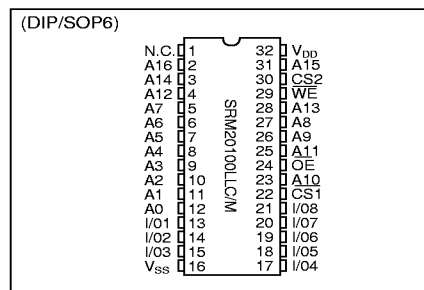
FEATURES

- Fast Access time SRM20100LLM70 70ns(Max.)
SRM20100LLM85 85ns(Max.)
SRM20100LLM10 100ns(Max.)
- Low supply current standby: 1.5μA(Typ.)
operation: 15μA/MHz(Typ.)
- Completely static No clock required
- Single power supply 5V±10%
- TTL compatible inputs and outputs
- 3-state output with wired-OR capability
- Non-volatile storage with back-up batteries
- Package SRM20100LLC70/85/10 DIP-32pin(plastic)
SRM20100LLM70/85/10 SOP6-32pin(plastic)
SRM20100LLTM70/85/10 TSOP(I)-32pin(plastic)
SRM20100LLRM70/85/10 TSOP(I)-32pin-R1(plastic)

BLOCK DIAGRAM



PIN CONFIGURATION



PIN DESCRIPTION

A0 to A16	Address Input
WE	Write Enable
OE	Output Enable
CS1, CS2	Chip Select
I/O1 to I/O8	Data I/O
VDD	Power Supply(+5V)
Vss	Power Supply(0V)
N. C.	No connection

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■ ABSOLUTE MAXIMUM RATINGS

(V_{SS}=0V)

Parameter	Symbol	Ratings	Unit
Supply voltage	V _{DD}	-0.5 to 7.0	V
Input voltage*	V _I	-0.5 to 7.0	V
Input/Output voltage*	V _{I/O}	-0.5 to V _{DD} +0.3	V
Power dissipation	P _D	1.0	W
Operating temperature	T _{opr}	0 to 70	°C
Storage temperature	T _{stg}	-65 to 150	°C
Soldering temperature and time	T _{sol}	260°C, 10s(at lead)	-

*V_I, V_{I/O} (Min.) = -3.0V (Pulse width is 50ns)

■ DC RECOMMENDED OPERATING CONDITIONS

(V_{SS}=0V, Ta=0 to 70°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply voltage	V _{DD}	-	4.5	5.0	5.5	V
	V _{SS}	-	0	0	0	V
Input voltage	V _{IH}	-	2.2	-	V _{DD} +0.3	V
	V _{IL}	-	-0.3*	-	0.8	V

*If pulse width is less than 50ns, it is -3.0V

■ ELECTRICAL CHARACTERISTICS

● DC Electrical Characteristics

(V_{DD}=5V±10%, V_{SS}=0V, Ta=0 to 70°C)

Parameter	Symbol	Conditions	SRM20100LLM70			SRM20100LLM85			SRM20100LLM10			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Input leakage	I _{LI}	V _I =0 to V _{DD}	-1	-	1	-1	-	1	-1	-	1	μA
Standby supply current	I _{DDS}	CS1=V _{IH} or CS2=V _{IL}	-	1.0	3.0	-	1.0	3.0	-	1.0	3.0	mA
	I _{DDS1}	CS1=CS2≥V _{DD} -0.2V or CS2≤0.2V	-	1.5	50	-	1.5	50	-	1.5	50	μA
Average operating current	I _{DDA}	V _I =V _{IL} , V _{IH} I _{I/O} =0mA, t _{cyc} =Min.	-	45	70	-	45	70	-	45	70	mA
	I _{DDA1}	V _I =V _{IL} , V _{IH} I _{I/O} =0mA, t _{cyc} =1μs	-	15	30	-	15	30	-	15	30	mA
Operating supply current	I _{DDO}	V _I =V _{IL} , V _{IH} I _{I/O} =0mA	-	15	35	-	15	35	-	15	35	mA
Output leakage	I _{LO}	CS1=V _{IH} or CS2=V _{IL} or \overline{WE} =V _{IL} or OE=V _{IH} , V _{I/O} =0 to V _{DD}	-1	-	1	-1	-	1	-1	-	1	μA
High level output voltage	V _{OH}	I _{OH} =-1.0mA	2.4	-	-	2.4	-	-	2.4	-	-	V
Low level output voltage	V _{OL}	I _{OL} =2.1mA	-	-	0.4	-	-	0.4	-	-	0.4	V

*Typical values are measured at Ta=25°C and V_{DD}=5.0V

● Terminal Capacitance

(f=1MHz, Ta=25°C)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Address Capacitance	C _{ADD}	V _{ADD} =0V	-	-	9	pF
Input Capacitance	C _I	V _I =0V	-	-	10	pF
I/O Capacitance	C _{I/O}	V _{I/O} =0V	-	-	10	pF

SRM20100LLM70/85/10

●AC Electrical Characteristics

○Read Cycle

(V_{DD}=5V±10%, V_{SS}=0V, Ta=0 to 70°C)

Parameter	Symbol	Conditions	SRM20100LLM70		SRM20100LLM85		SRM20100LLM10		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
Read cycle time	t _{RC}	*1	70	-	85	-	100	-	ns
Address access time	t _{ACC}		-	70	-	85	-	100	ns
Chip select1 access time	t _{ACS1}		-	70	-	85	-	100	ns
Chip select2 access time	t _{ACS2}		-	70	-	85	-	100	ns
Output enable access time	t _{OE}		-	40	-	45	-	50	ns
Chip select1 output set time	t _{CLZ1}	*2	10	-	10	-	10	-	ns
Chip select1 output floating	t _{CHZ1}		-	30	-	30	-	35	ns
Chip select2 output set time	t _{CLZ2}		10	-	10	-	10	-	ns
Chip select2 output floating	t _{CHZ2}		-	30	-	30	-	35	ns
Output enable output set time	t _{OLZ}		5	-	5	-	5	-	ns
Output enable output floating	t _{OHZ}		-	30	-	30	-	35	ns
Output hold time	t _{OH}	*1	10	-	10	-	10	-	ns

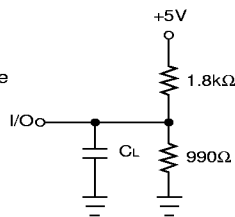
○Write Cycle

(V_{DD}=5V±10%, V_{SS}=0, Ta=0 to 70°C)

Parameter	Symbol	Conditions	SRM20100LLM70		SRM20100LLM85		SRM20100LLM10		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
Write cycle time	t _{WC}	*1	70	-	85	-	100	-	ns
Chip select time1	t _{CW1}		60	-	70	-	80	-	ns
Chip select time2	t _{CW2}		60	-	70	-	80	-	ns
Address enable time	t _{AW}		60	-	70	-	80	-	ns
Address setup time	t _{AS}		0	-	0	-	0	-	ns
Write pulse width	t _{WP}		55	-	65	-	75	-	ns
Address hold time	t _{WR}		0	-	0	-	0	-	ns
Input data setup time	t _{DW}		30	-	35	-	40	-	ns
Input data hold time	t _{DH}		0	-	0	-	0	-	ns
WE Output floating	t _{WHZ}	*2	-	30	-	30	-	35	ns
WE Output setup time	t _{OW}		5	-	5	-	5	-	ns

*1 Test Conditions

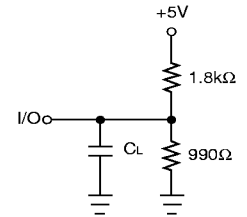
1. Input pulse level: 0.6V to 2.4V
2. t_r = t_f = 5ns
3. Input and output timing reference levels : 1.5V
4. Output load C_L = 100pF



C_L=100pF (Includes Jig Capacitance)

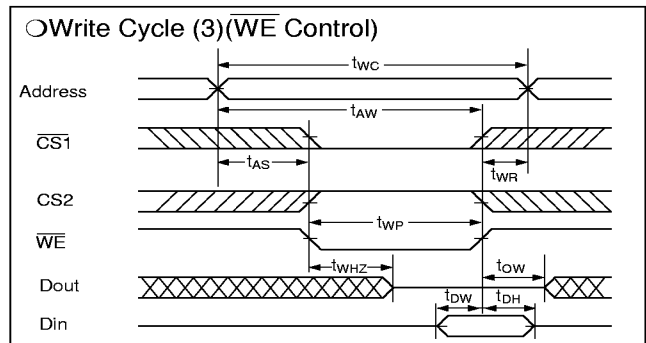
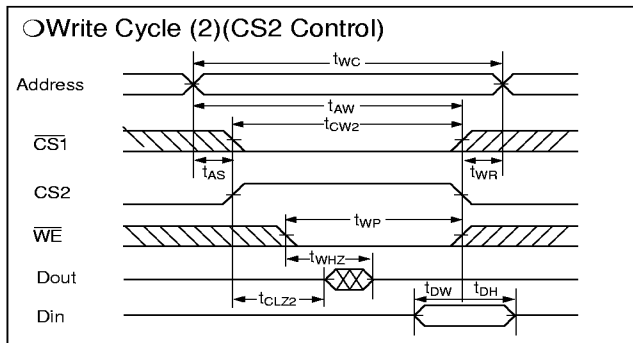
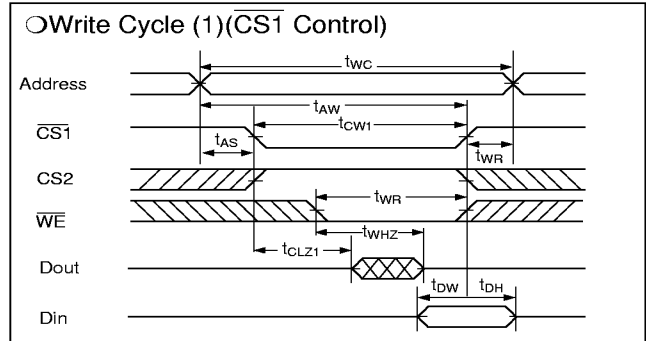
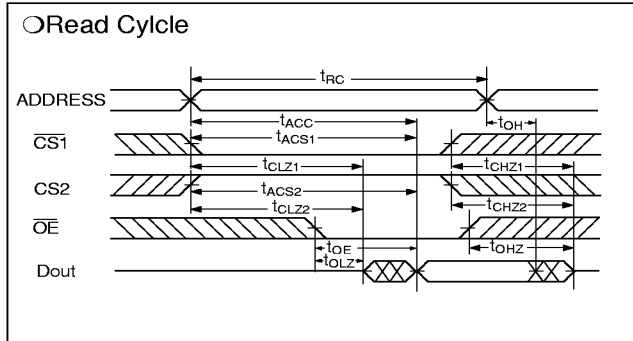
*2. Test Conditions

1. Input pulse level : 0.6V to 2.4V
2. t_r = t_f = 5ns
3. Input timing reference levels: 1.5V
4. Output timing reference levels: ±200mV(the level displaced from stable output voltage level)
5. Output load C_L = 5pF



C_L=5pF (Includes Jig Capacitance)

●Timing chart



- Note
1. During read cycle time, \overline{WE} is to be "H" level.
 2. During write cycle time that is controlled by $\overline{CS1}$ or $\overline{CS2}$, Output Buffer is in high impedance state, whether \overline{OE} level is "H" or "L".
 3. During write cycle time that is controlled by \overline{WE} , Output Buffer is high impedance state if \overline{OE} is "H" level.
 4. When I/O terminals are output mode, be careful that do not give the opposite signals to the I/O terminals.

●DATA RETENTION CHARACTERISTIC WITH LOW VOLTAGE POWER SUPPLY

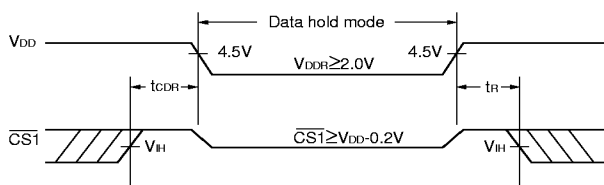
(Ta=0 to 70°C)

Parameter	Symbol	Conditions	Min.	Typ.*1	Max.	Unit
Data retention Supply voltage	V_{DDR}		2.0	-	5.5	V
Data retention current	I_{DDR}	$V_{DD}=3V$ $\overline{CS1}=\overline{CS2}\geq V_{DD}-0.2V$ or $\overline{CS2}\leq 0.2V$	-	1	15	μA
			-	-	3*2	
Chip select data hold time	t_{CDR}		0	-	-	ns
Operation recovery time	t_R		5	-	-	ms

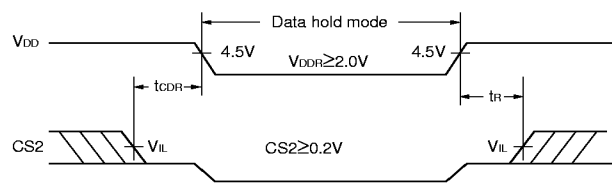
*1 Ta = 25°C

*2 Ta = 0 to 40°C

Data retention timing (CS1 Control)



Data retention timing (CS2 Control)



■ FUNCTIONS

● Truth Table

$\overline{CS1}$	CS2	\overline{OE}	\overline{WE}	DATA I/O	Mode	I_{DD}
H	X	X	X	Hi-Z	Standby	I_{DDS}, I_{DDS1}
X	L	X	X	Hi-Z	Standby	I_{DDS}, I_{DDS1}
L	H	X	L	Input data	Write	I_{DDO}
L	H	L	H	Output data	Read	I_{DDO}
L	H	H	H	Hi-Z	Output disable	I_{DDO}

X : "H" or "L"

● Reading data

Data is able to be read when the address is set while holding $\overline{CS1} = "L"$, $CS2 = "H"$, $\overline{OE} = "L"$ and $\overline{WE} = "H"$. Since DATA I/O terminals are in high impedance state when $\overline{OE} = "H"$, the data bus line can be used for any other objective, then access time apparently is able to be cut down.

● Writing data

There are the following four ways of writing data into the memory.

- (1) Hold $CS2 = "H"$, $\overline{WE} = "L"$, set addresses and give "L" pulse to $\overline{CS1}$.
- (2) Hold $\overline{CS1} = "L"$, $\overline{WE} = "L"$, set addresses and give "H" pulse to $CS2$.
- (3) Hold $\overline{CS1} = "L"$, $CS2 = "H"$, set addresses and give "L" pulse to \overline{WE} .
- (4) After setting addresses, give "L" pulse to $\overline{CS1}$, \overline{WE} and give "H" pulse to $CS2$.

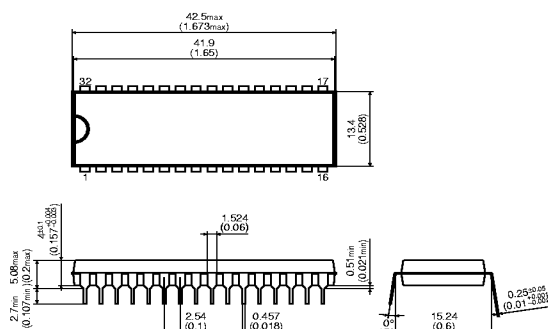
Anyway, data on the Data I/O terminals are latched up into the SRM20100LLM70/85/10 at the end of the period that $\overline{CS1}$, \overline{WE} are "L" level, and $CS2$ is "H" level. As Data I/O terminals are in high impedance state when any of $\overline{CS1}$, $\overline{OE} = "H"$ or $CS2 = "L"$ the contention on the data bus can be avoided.

● Standby Mode

When $\overline{CS1}$ is "H" or $CS2$ is "L" level, the SRM20100LLM70/85/10 is in the standby mode which has retaining data operation. In this case Data I/O terminals are Hi-Z, and all inputs of addresses, \overline{WE} and data can be any "H" or "L". When $\overline{CS1}$ and $CS2$ level are in the range over $V_{DD}-0.2V$, $CS2$ level is in the range under $0.2V$, in the SRM20100LLM70/85/10 there is almost no current flow except through the high resistance parts of the memory.

■ PACKAGE DIMENSIONS

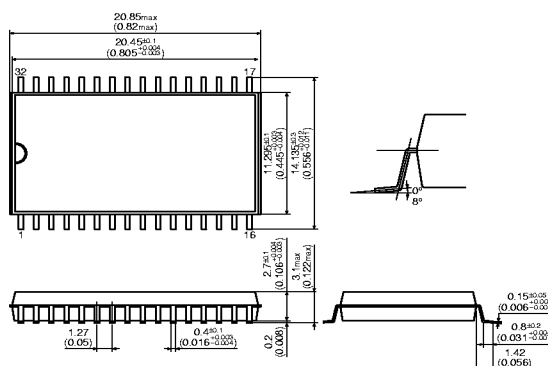
Plastic DIP-32pin*1



Unit:mm
(inch)

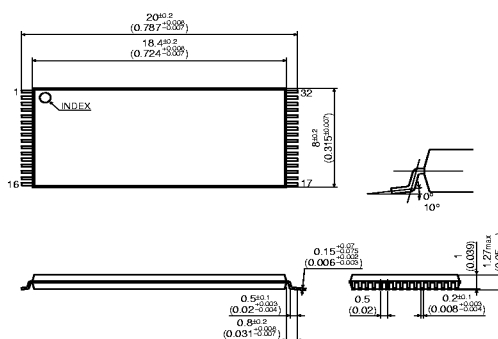
*1 SRM20100LLC70/85/10 has the same characteristics as SRM20100LLM70/85/10.

Plastic SOP6-32pin



Unit:mm
(inch)

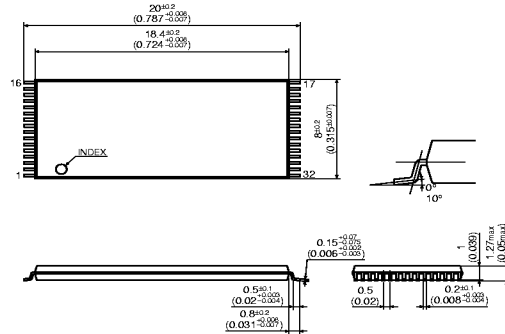
Plastic TSOP (I)-32pin*2



Unit:mm
(inch)

*2 SRM20100LLTM55/70/85/10 has the same characteristics as SRM20100LLM70/85/10.

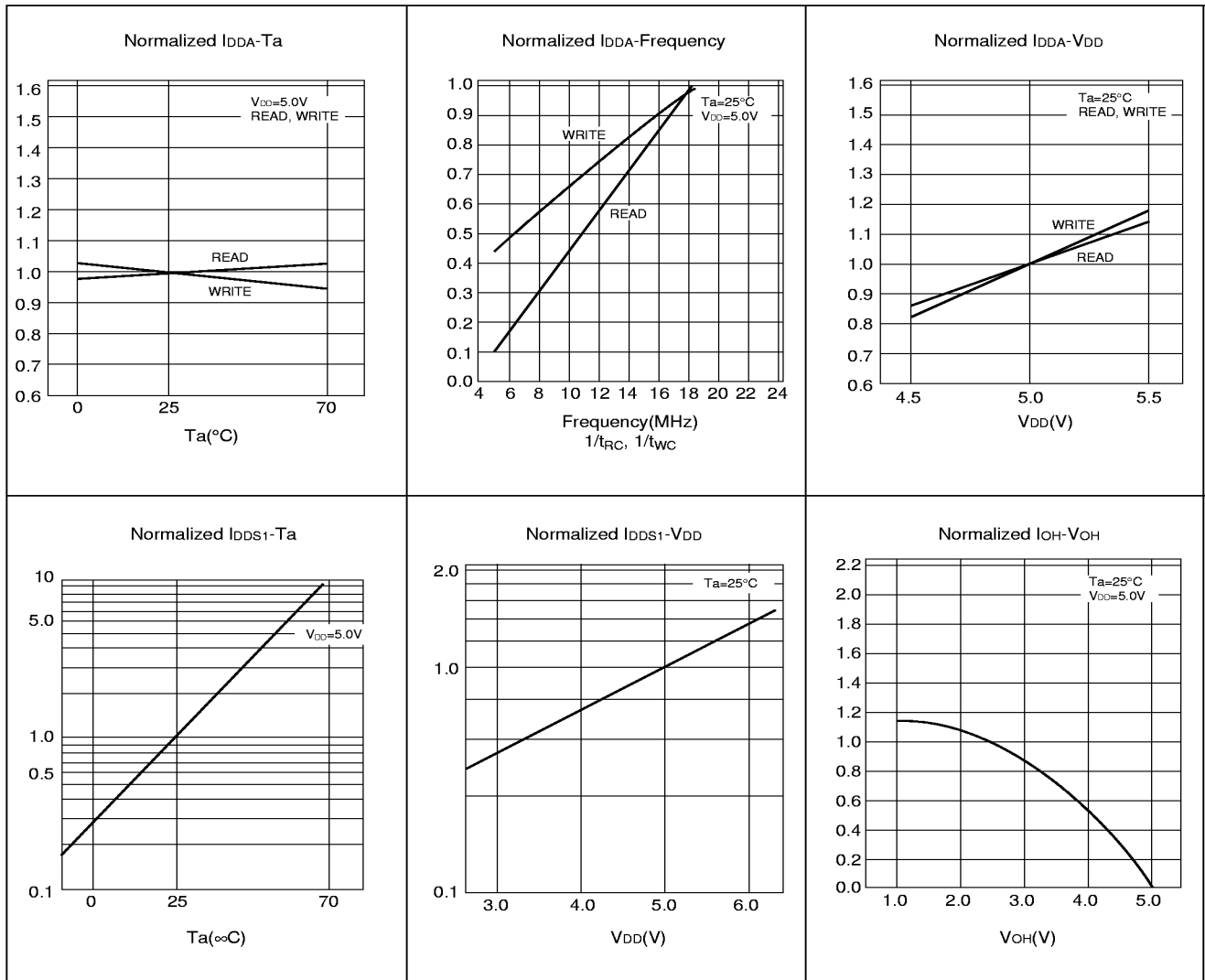
Plastic TSOP (I)-32pin-R1*3

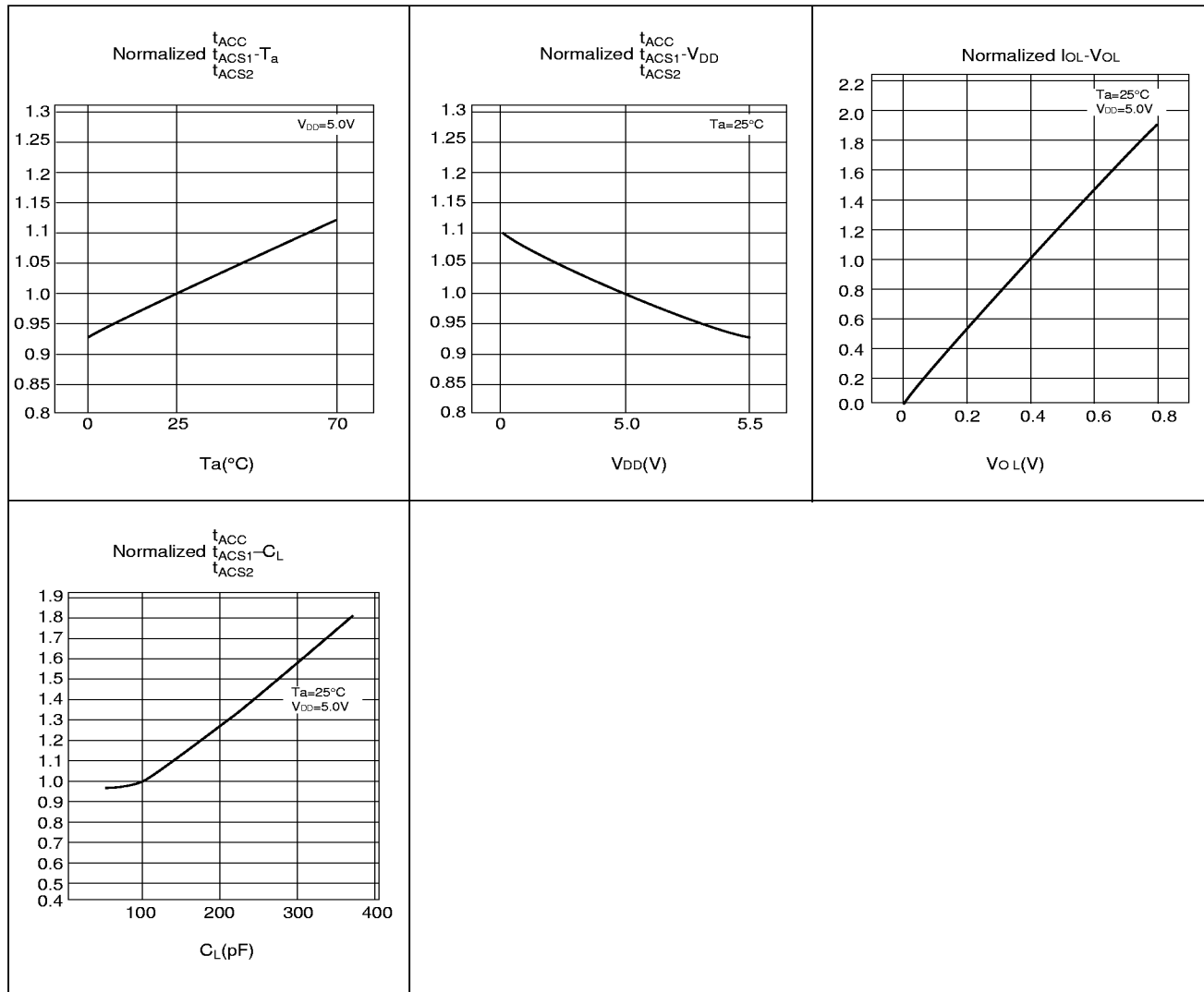


Unit:mm
(inch)

*3 SRM20100LLRM55/70/85/10 has the same characteristics as SRM20100LLM55/70/85/10.

CHARACTERISTICS CURVES





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